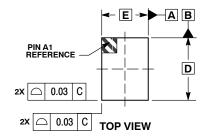




## WLCSP12, 1.376x1.025x0.68 CASE 567MW ISSUE A

## DATE 07 JUN 2017



DETAIL A

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1 2 3 BOTTOM VIEW

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Α1

SIDE VIEW

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SEATING PLANE

e/2

C

е

0.10 C

0.05 C

//

 $\square$ 

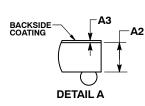
0.05 C A B

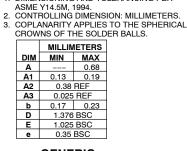
0.03 C

 $\oplus$ 

NOTE 3

12X Ø **b** 





1. DIMENSIONING AND TOLERANCING PER

NOTES:

## GENERIC MARKING DIAGRAM\*

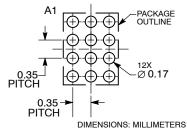


- A = Assembly Location
- L = Wafer Lot
- Y = Year
- W = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.

## RECOMMENDED SOLDERING FOOTPRINT\*



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION: WLCSP12, 1.376X1.025X0.68		68	PAGE 1 OF 1	
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